



2825

TRANSMITTAL LETTER
(General - Patent Pending)

Docket No.
PHNL000627

Application Of: **Verhaar et al.**

Serial No. 09/989,250	Filing Date 11/20/2001	Examiner Luu, C.	Group Art Unit 2825
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Title: **METHOD OF FORMING A SEMICONDUCTOR STRUCTURE**

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is: **Amendment in 5 pages**
2 Return Receipt Postcards

in the above identified application.

- ☒ No additional fee is required.
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Dated: **February 5, 2003**

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I certify that this document and fee is being deposited on 2/5/2003 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.	
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DOCKET NO. PHNL000627

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Verhaar et al.)
)
Application No.: 09/989,250)
)
Filed: 11/20/2001)
)
For: METHOD OF FORMING A)
SEMICONDUCTOR STRUCTURE)

Examiner: Luu, C.
Art Unit: 2825

JH/gmdt B

Box Non-Fee Amendment
Commissioner for Patents
Washington D.C. 20231

2/14/03

Nbm

AMENDMENT

Sir:

In response to the Office Action of November 6, 2002, Applicants respectfully request that the above-identified application be reconsidered in view of the amendments and remarks that follow, and that the application be passed to issue.

In the Specification:

On page 1, prior to first paragraph, please add the heading:

B'

FIELD OF THE INVENTION

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